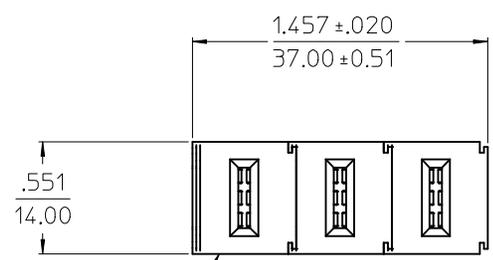
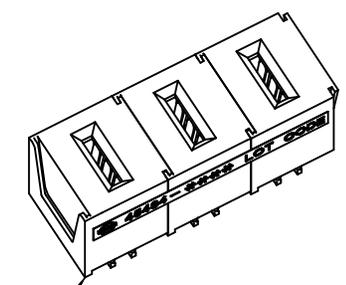
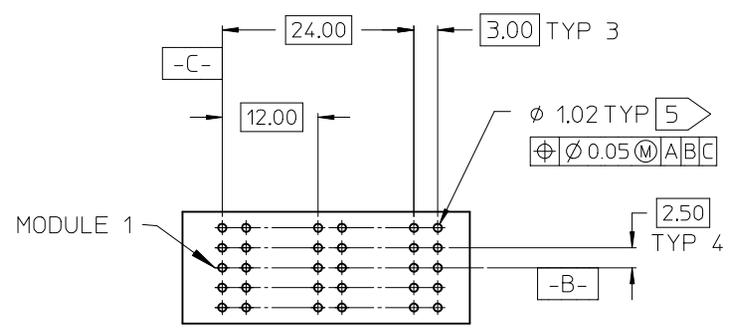
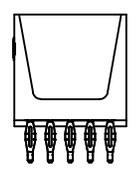
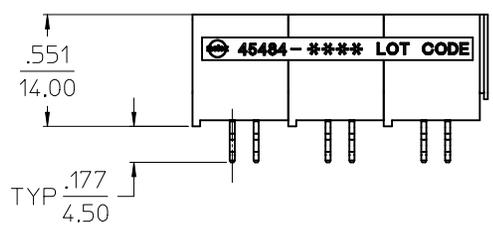


- NOTES:
1. MATERIAL: LCP, GLASS FILLED, UL94V-0, BLACK.
CONTACTS: COPPER ALLOY
 2. FINISH: SELECT GOLD: 30 MI MIN.
SELECT TIN: 100 MI MIN.
BOTH OVER NICKEL
 3. PRODUCT SPECIFICATION: PS-45424-001.
 4. PACKAGING SPECIFICATION: PK-45484-001.
 - 5 PCB HOLE SPECIFICATION: PS-45424-001.



MODULE 1



MODULE 1

PD	PD	PD
216	216	216

PCB LAYOUT: COMPONENT SIDE
PCB THICKNESS: .093/2.36
PCB TOLERANCE ±.002/0.05

GEOM TOL PCB	DESCRIPTION
EC NO: UCP2005-2724	
DRWN: ADRATNOI2005/07/07	
CHKD: KSAMIEC 2005/07/08	
APPR: APATEL 2005/08/17	
D1	REV

QUALITY SYMBOLS

GENERAL TOLERANCES (UNLESS SPECIFIED)	mm	INCH
	4 PLACES ± ---	± ---
	3 PLACES ± ---	± .010
	2 PLACES ± 0.25	± .015
	1 PLACE ± 0.38	± ---
	ANGULAR ± 1/2°	
DRAFT WHERE APPLICABLE		
MUST REMAIN WITHIN DIMENSIONS		

SCALE 1:1	DESIGN UNITS METRIC
DIMENSION STYLE IN/MM	
DRAWN BY SAMIEC	DATE 2003/03/25
CHECKED BY MARGULIS	DATE 2003/03/25
APPROVED BY MARGULIS	DATE 2003/03/25

THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	
TITLE POWER DOCK ASSEMBLY SOCKET VERTICAL CPI		
MOLEX INCORPORATED		
MATERIAL NO. 45484-0004	DOCUMENT NO. SD-45484-004	SHEET NO. 1 OF 1
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